

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Darbha *et al.*

Art Unit:

Serial No.:

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Filed:

Examiner:

**Title: STRESS REDUCTION IN FLIP-CHIP PBGA PACKAGING BY UTILIZING
SEGMENTED CHIPS AND/OR CHIP CARRIERS**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Preliminary Amendment

Sir:

Kindly enter this amendment prior to initial examination